



## N-Channel 30-V (D-S), 175°C MOSFET

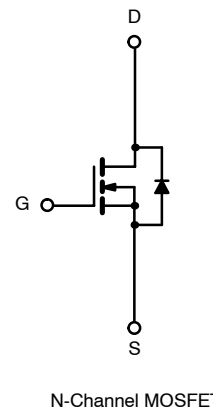
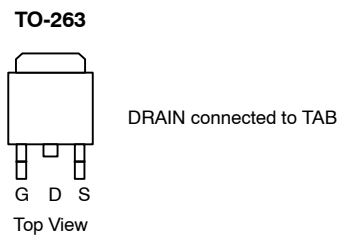
| PRODUCT SUMMARY   |                           |           |
|-------------------|---------------------------|-----------|
| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A) |
| 30                | 0.0095 @ $V_{GS} = 20$ V  | 70        |
|                   | 0.014 @ $V_{GS} = 4.5$ V  | 58        |

### FEATURES

- TrenchFET® Power MOSFET
- Optimized for High- or Low-Side
- New Low Thermal Resistance Package
- 100%  $R_g$  Tested

### APPLICATIONS

- DC/DC Converters
- Synchronous Rectifiers



Ordering Information: SUM70N03-09CP  
SUM70N03-09CP-E3 (Lead Free)

| ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED) |                |                           |                  |
|---|----------------|---------------------------|------------------|
| Parameter   | Symbol         | Limit                     | Unit             |
| Drain-Source Voltage  | $V_{DS}$       | 30                        | V                |
| Gate-Source Voltage   | $V_{GS}$       | $\pm 20$                  |                  |
| Continuous Drain Current ( $T_J = 175^\circ\text{C}$ )                      | $I_D$          | $T_C = 25^\circ\text{C}$  | 70               |
|   |                | $T_C = 125^\circ\text{C}$ | 40               |
| Pulsed Drain Current  | $I_{DM}$       | 100                       | A                |
| Avalanche Current   | $I_{AR}$       | 35                        |                  |
| Repetitive Avalanche Energy <sup>a</sup>                                    | $E_{AR}$       | 61 <sup>b</sup>           | mJ               |
| Maximum Power Dissipation <sup>a</sup>                                      | $P_D$          | $T_C = 25^\circ\text{C}$  | 93               |
|   |                | $T_A = 25^\circ\text{C}$  | 3.75             |
| Operating Junction and Storage Temperature Range                            | $T_J, T_{stg}$ | -55 to 175                | $^\circ\text{C}$ |

| THERMAL RESISTANCE RATINGS |            |       |                    |
|----------------------------|------------|-------|--------------------|
| Parameter                  | Symbol     | Limit | Unit               |
| Junction-to-Ambient        | $R_{thJA}$ | 40    | $^\circ\text{C/W}$ |
| Junction-to-Case           | $R_{thJC}$ | 1.6   |                    |

Notes

- Duty cycle  $\leq 1\%$ .
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).

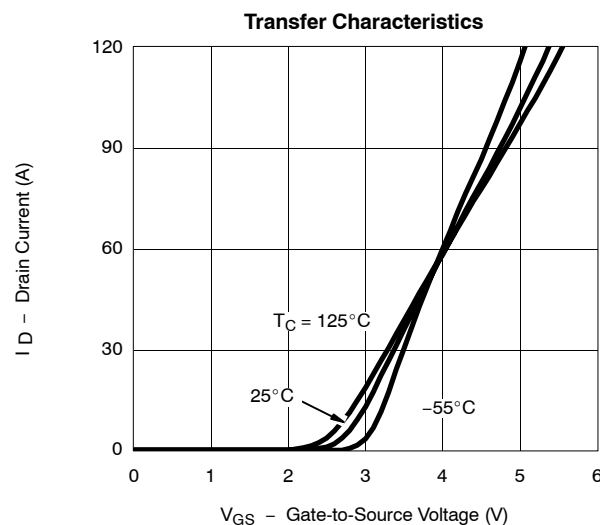
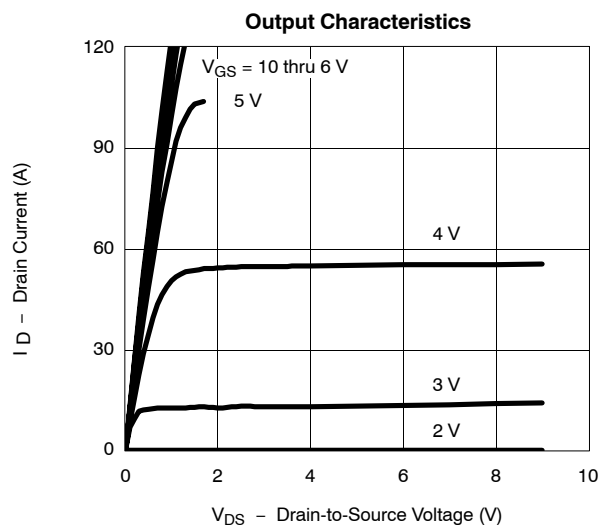
### SPECIFICATIONS (T<sub>J</sub> = 25 °C UNLESS OTHERWISE NOTED)

| Parameter  | Symbol               | Test Condition   | Min | Typ <sup>a</sup> | Max    | Unit |
|--|----------------------|--|-----|------------------|--------|------|
| <b>Static</b>  |                      |  |     |                  |        |      |
| Drain-Source Breakdown Voltage   | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA   | 30  |                  |        | V    |
| Gate Threshold Voltage   | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA  | 1.0 |                  | 3.0    |      |
| Gate-Body Leakage  | I <sub>GSS</sub>     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V   |     |                  | ±100   | nA   |
| Zero Gate Voltage Drain Current  | I <sub>DSS</sub>     | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V  |     |                  | 1      | μA   |
|  |                      | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C   |     |                  | 250    |      |
| On-State Drain Current <sup>b</sup>  | I <sub>D(on)</sub>   | V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V  | 100 |                  |        | A    |
| Drain-Source On-State Resistance <sup>b</sup>                                | r <sub>DS(on)</sub>  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A  |     | 0.0076           | 0.0095 | Ω    |
|  |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C   |     |                  | 0.015  |      |
|  |                      | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A   |     | 0.0115           | 0.014  |      |
| Forward Transconductance <sup>b</sup>  | g <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A  | 20  |                  |        | S    |
| <b>Dynamic<sup>a</sup></b>   |                      |  |     |                  |        |      |
| Input Capacitance  | C <sub>iss</sub>     | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz   |     | 2200             |        | pF   |
| Output Capacitance   | C <sub>oss</sub>     |  |     | 410              |        |      |
| Reverse Transfer Capacitance   | C <sub>rss</sub>     |  |     | 180              |        |      |
| Gate Resistance  | R <sub>g</sub>       |  | 0.5 | 1.5              | 2.1    | Ω    |
| Total Gate Charge <sup>c</sup>   | Q <sub>g</sub>       | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 50 A  |     | 31               | 45     | nC   |
| Gate-Source Charge <sup>c</sup>  | Q <sub>gs</sub>      |  |     | 7.5              |        |      |
| Gate-Drain Charge <sup>c</sup>   | Q <sub>gd</sub>      |  |     | 5.0              |        |      |
| Turn-On Delay Time <sup>c</sup>  | t <sub>d(on)</sub>   | V <sub>DD</sub> = 15 V, R <sub>L</sub> = 0.3 Ω<br>I <sub>D</sub> = 50 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 2.5 Ω |     | 9                | 15     | ns   |
| Rise Time <sup>c</sup>   | t <sub>r</sub>       |  |     | 80               | 120    |      |
| Turn-Off Delay Time <sup>c</sup>   | t <sub>d(off)</sub>  |  |     | 22               | 35     |      |
| Fall Time <sup>c</sup>   | t <sub>f</sub>       |  |     | 8                | 12     |      |
|  |                      |  |     |                  |        |      |
| <b>Source-Drain Diode Ratings and Characteristic (T<sub>C</sub> = 25 °C)</b> |                      |  |     |                  |        |      |
| Pulsed Current   | I <sub>SM</sub>      |  |     |                  | 100    | A    |
| Diode Forward Voltage <sup>b</sup>   | V <sub>SD</sub>      | I <sub>F</sub> = 50 A, V <sub>GS</sub> = 0 V   |     | 1.2              | 1.5    | V    |
| Source-Drain Reverse Recovery Time   | t <sub>rr</sub>      | I <sub>F</sub> = 50 A, di/dt = 100 A/μs  |     | 35               | 70     | ns   |

#### Notes

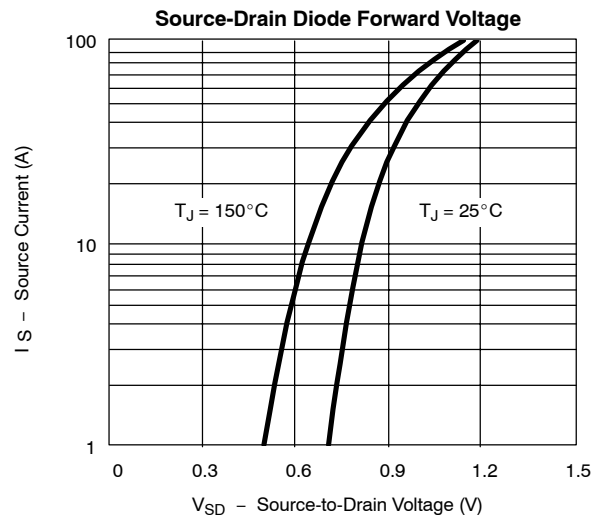
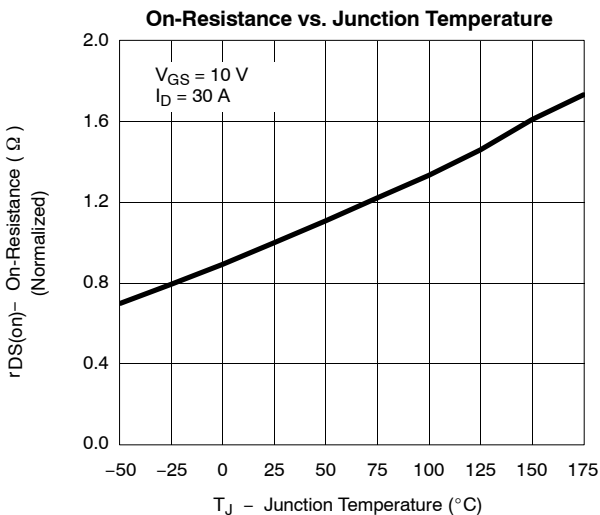
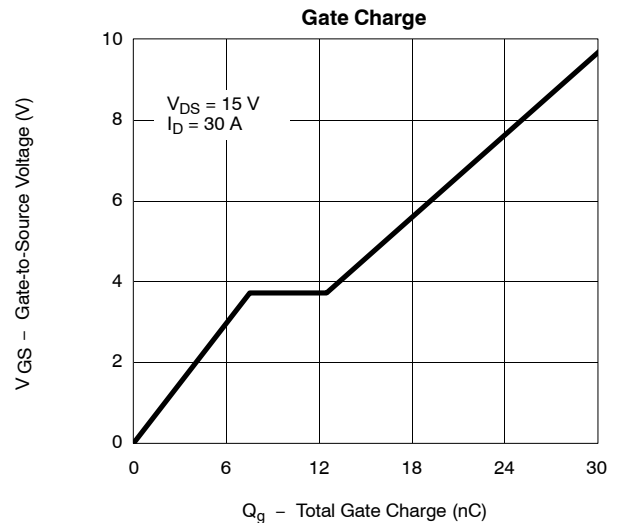
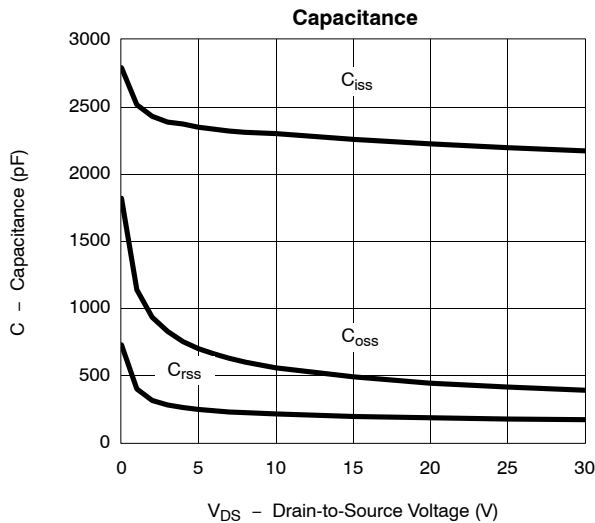
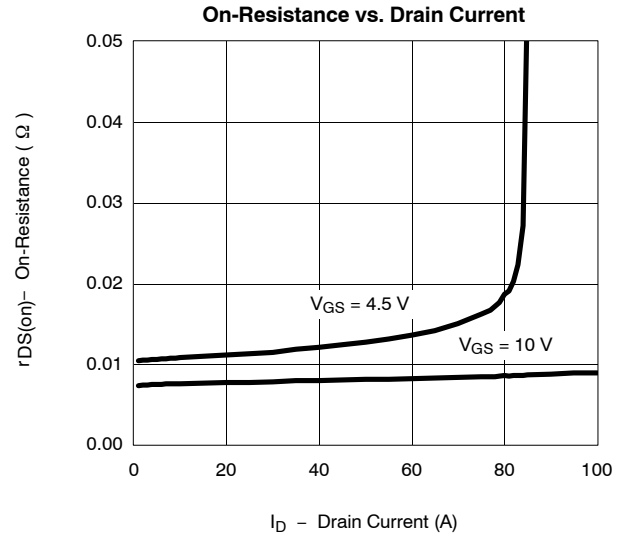
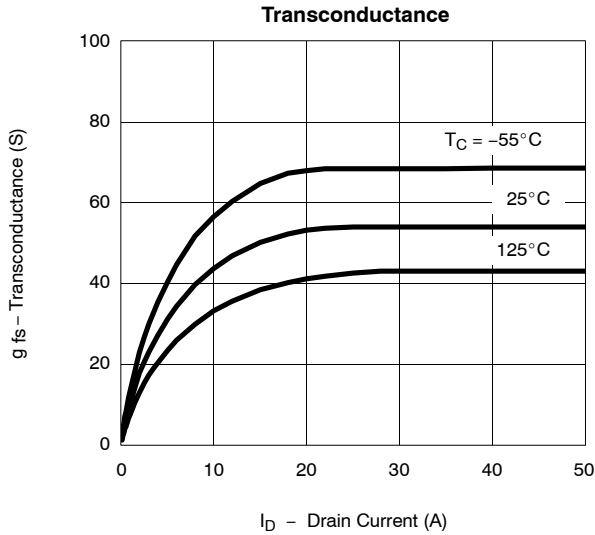
- Guaranteed by design, not subject to production testing.
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- Independent of operating temperature.

### TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)



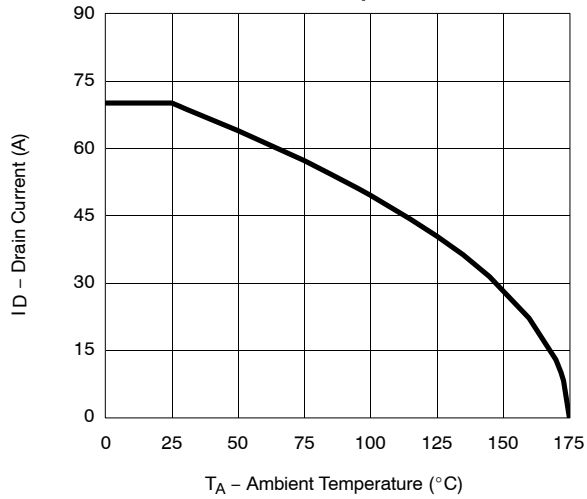


**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

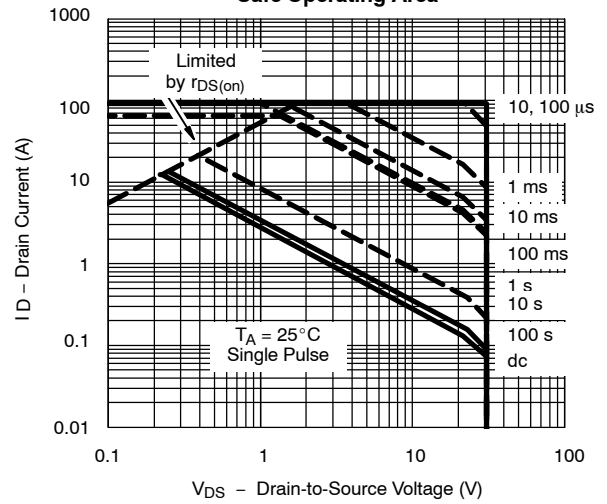


**THERMAL RATINGS**

Maximum Drain Current vs. Ambient Temperature



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

